

04-25-2003



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4-21-03

Docket No.: **01201.061**

To the Honorable Commissioner for Patents: Please record the attached original documents or copy thereof.

1. A. Name of conveying party(ies):
Tsumoru HIRANO
Masaru NAKAMURA

B. Additional name(s) of conveying party(ies)
attached?

☐ Yes ☒ No

2. A. Name and address of receiving party(ies):
NAKAJIMA COPPER WORKS, INC.
10-1, Maruyama,
Kamifukuoka-shi, Saitama, Japan

B. Additional name(s) & address(es) attached?

☐ Yes ☒ No

3. A. Nature of conveyance:

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other _____

B. Execution Date: March 20, 2003

4. A. If this document is being filed together with a new application, the execution date of the application is:

B. Patent Application No.(s) 10/369,139

C. Patent No.(s) _____

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence
concerning document should be mailed:

Name: Matthew Johnston

Address: LINIAK, BERENATO & WHITE
6550 ROCK SPRING DRIVE
SUITE 240
Bethesda, Maryland 20817
Telephone: (301) 896-0600
Facsimile: (301) 896-0607

6. Total number of applications and patents involved: 1

7. A. Total fee (37 CFR 3.41).....\$ 40.00

B. Check Enclosed

8. Credit any overpayment or charge any underpayment
to deposit account number 50-0548.

9. **Statement and signature.**

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Matthew Johnston, Registration No. 41,096

Date: April 21, 2003

Total number of pages including cover sheet, attachments, and document: 2

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40.00 DP

Assignment of Rights, Title and Interest in Invention

This is an Assignment of the following rights, title and interest: (check all that apply):

- ☒ [X] United States of America rights, title and interest in the invention
☐ [] Foreign rights, title and interest in the invention
☐ [] United States Patent Application Serial No.
 Date of Execution:
 Date of Filing:
☐ [] United States Patent No(s).
☐ [] Other (specify):

Title of the Invention: SOLDERING TOOL.

Inventor(s)
(Assignors)

Name(s) Address(es)

1. Tsumoru HIRANO c/o Nakajima Copper Works, Inc., Ranzan Factory, 683, Aza-Minamimon, Kamagata, Ranzan-cho, Hiki-gun, Saitama, Japan

2. Masaru NAKAMURA c/o Nakajima Copper Works, Inc., Ranzan Factory, 683, Aza-Minamimon, Kamagata, Ranzan-cho, Hiki-gun, Saitama, Japan

Assignee

Name: NAKAJIMA COPPER WORKS, INC.

Address: 10-1, Maruyama, Kamifukuoka-shi, Saitama, Japan

Whereas, we, the above-identified Inventors, have invented certain new and useful improvements in the Invention identified above and described in the above-identified patent application(s) and/or patent(s) (hereinafter referred to as "Invention");

And, whereas we desire to assign our above-identified rights, title and interest in the Invention to the above-identified Assignee;

Now, that for good and valuable consideration, the receipt whereof is hereby acknowledged;

We hereby assign, sell and transfer our above-identified rights, title and interest in said Invention, said application(s) as identified above, including any divisions, continuations, and continuations-in-part thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted or have granted for said Invention, and in and to any and all reissues and reexaminations thereof, and in and to any and all priority rights, Convention rights, and other benefits accruing or to accrue to us with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, unto said Assignee.

And we hereby authorize and request the Commissioner of Patents and Trademarks to issue any United States Patent which may issue for said Invention to said Assignee, as assignee of the whole right, title and interest thereto;

And we further agree to sign and execute all necessary and lawful future documents, including applications for foreign patents, for filing divisions, continuations and continuations-in-part of said application for patent, and/or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid Invention, as the Assignee or its Designee(s) may from time to time require and prepare at its own expense.

March 20, 2003

Date

Tsumoru HIRANO
 Tsumoru HIRANO

March 20, 2003

Date

Masaru NAKAMURA
 Masaru NAKAMURA

☐ Additional Inventors and Signatures are attached